TOSHIBA PHOTO-INTERRUPTER INFRARED LED + PHOTOTRANSISTOR

TLP803

TIMING SENSORS FOR PRINTERS AND ELECTRIC TYPEWRITERS

EDGE SENSORS, OPTO-ELECTRONIC SWITCHES POSITION AND ROTATION SENSORS

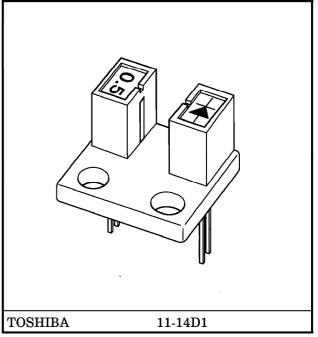
The TLP803 photo-interrupter has a wide detection gap and can be used for high-speed detection.

• Gap : 5 mm

• Resolution : Slit width = 0.5 mm

• High-speed response : t_r , $t_f = 6 \mu s$ (typ.)

• Package material : Polycarbonate

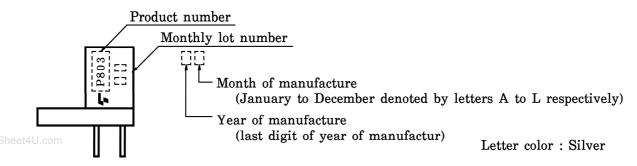


Weight: 0.98 g (typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
LED	Forward Current	$I_{\mathbf{F}}$	50	mA	
	Forward Current Derating (Ta > 25°C)	ΔI _F /°C	-0.33	mA/°C	
	Reverse Voltage	v_{R}	5	V	
- R	Collector-Emitter Voltage	v_{CEO}	35	V	
CTOR	Emitter Collector Voltage	VECO	5	V	
	Collector Power Dissipation	PC	75	mW	
DETE	Collector Power Dissipation Derating (Ta > 25°C)	ΔP _C /°C	-1	mW/°C	
	Collector Current	$I_{\mathbf{C}}$	50	mA	
Op	perating Temperature Range	$T_{ m opr}$	-25~85	°C	
Sto	orage Temperature Range	$\mathrm{T_{stg}}$	-40~100	°C	

MARKINGS



OPTICAL AND ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
LED	Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F}=10{ m mA}$	1.00	1.15	1.30	V
	Reverse Current	I_{R}	$V_R = 5 V$	_	_	10	μ A
	Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	$ m I_F = 20~mA$		940	-	nm
DETECTOR	Dark Current	ID (ICEO)	$V_{ m CE} = 24 m V, I_{ m F} = 0$	1		0.1	μ A
	Peak Sensitivity Wavelength	$\lambda_{\mathbf{P}}$	_	1	820	1	nm
COUPLED	Current Transfer Ratio	I _C /I _F	$V_{ m CE}=5~{ m V},~{ m I_F}=20~{ m mA}$	2.5	_	60	%
	Collector-Emitter Saturation Voltage	V _{CE} (sat)	$I_{\mathrm{F}}=20\mathrm{mA},~I_{\mathrm{C}}=0.25\mathrm{mA}$		0.1	0.4	V
	Rise Time	$t_{\mathbf{r}}$	$V_{CC} = 5 \text{ V}, I_{C} = 2 \text{ mA},$		6	_	
	Fall Time	t_f	$ m R_L = 100~\Omega$		6	_	μ s

PRECAUTIONS

The following points must be borne in mind.

1. Soldering temperature: 260°C max

Soldering time: 5 s max

(Soldering must be performed 1.5 mm under the package body.)

2. Clean only the soldered part of the leads. Do not immerse the entire package in the cleaning solvent.

3. The package is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol and aliphatic hydrocarbons, however, with petrochemicals (such as benzene, toluene and acetone), alkalis, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate may crack, swell or melt. Please take this into account when chosing a packaging material by referring to the table below.

<Chemicals which should not be used with polycarbonate>

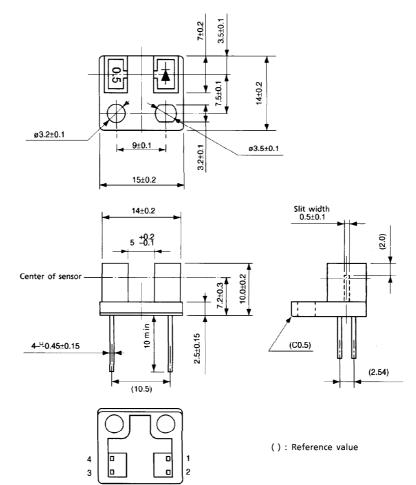
	PHENOMENON	CHEMICALS	
A	Staining and slight deterioration	• Nitric acid (diluted), hydrogen peroxide, chlorine	
В	Cracking, crazed or swelling	 Acetic acid (70% or more) Gasoline Methyl ethyl ketone, ethyl acetate, butyl acetate Ethyl methacrylate, ethyl ether, MEK Acetone, m-amino alcohol, carbon tetrachloride Carbon disulfide, trichloroethylene, cresol Thinners, oil of turpentine Triethanolamine, TCP, TBP 	
С	Melting { }: Used as solvent	 Concentrated sulfuric acid Benzene Styrene, acrylonitrile, vinyl acetate Ethylenediamine, diethylenediamine Chloroform, methyl chloride, tetrachloromethane, dioxan 1, 2-dichloroethane 	
D	Decomposition	Ammonia waterOther alkalis	

- 4. Mount the device on a level surface.
- 5. Screws should be tightened to a clamping torque of 0.59 N·m.
- 6. Conversion efficiency falls over time due to the current which flows in the infrared LED. When designing a circuit, take into account this change in conversion efficiency over time. The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1:1.

$$\frac{I_{C}/I_{F}(t)}{I_{C}/I_{F}(0)} = \frac{P_{O}(t)}{P_{O}(0)}$$

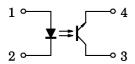
PACKAGE DIMENSIONS 11-14D1

Unit: mm



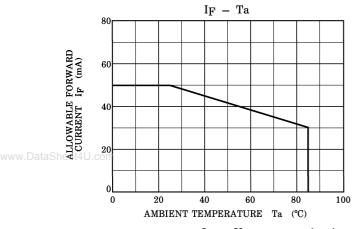
Weight: 0.98 g (typ.)

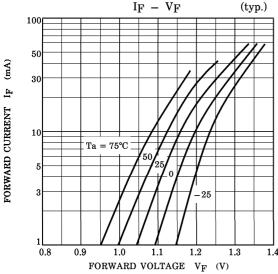
PIN CONNECTION

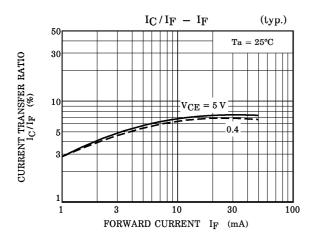


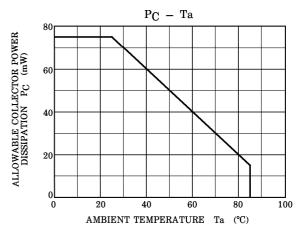
- 1. Anode
- 2. Cathode
- 3. Collector
- 4. Emitter

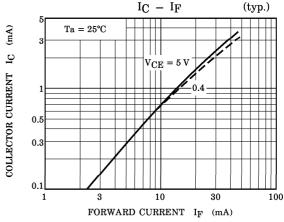
TOSHIBA TLP803

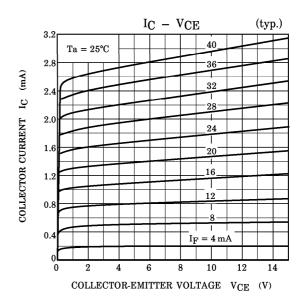




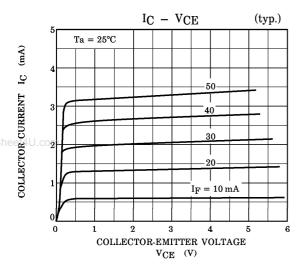


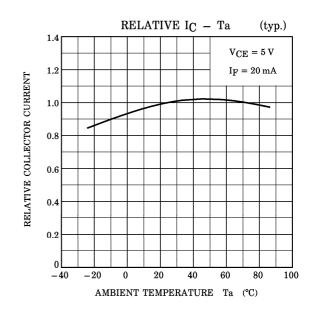


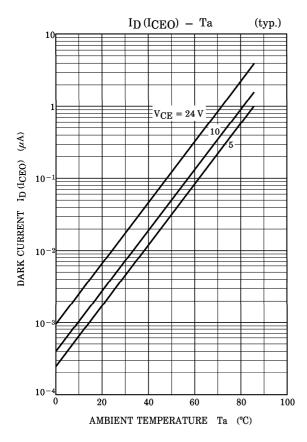


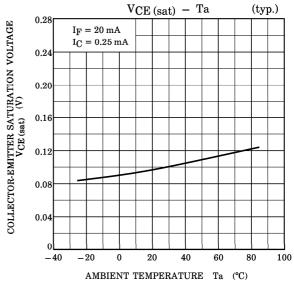


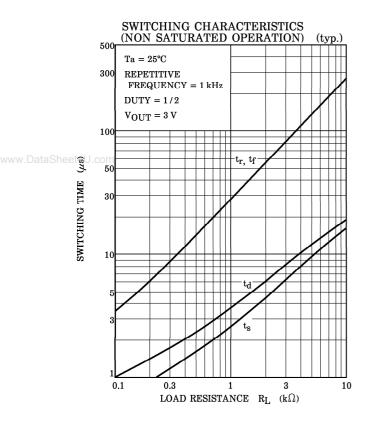
TOSHIBA TLP803

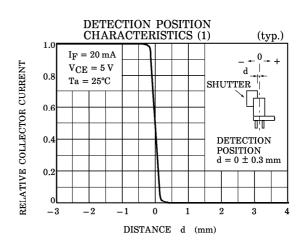


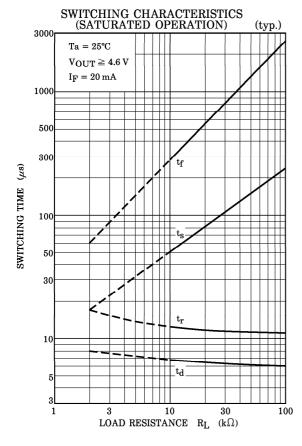


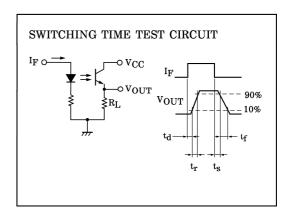








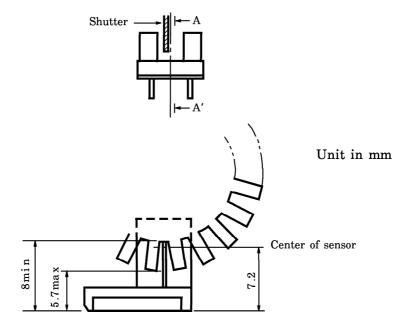




RELATIVE POSITIONING OF SHUTTER AND DEVICE

For normal operation position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.

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Cross section between A and A'

nunu Data Chaat III aan

RESTRICTIONS ON PRODUCT USE

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